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# Effect of composition and structure on specific resistivity of SiC fibers

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**Abstract:** Four kinds of SiC fibers with different specific resistivities were prepared by the pyrolysis of cured polycarbosilane fiber. The results show that SiC fibers with different specific resistivities can be obtained by changing the curing and pyrolysis conditions. And the free carbon content and the ability to crystallize no longer affect the specific resistivities notably with the time when the fiber is covered with an excess carbon layer, and the fiber has a low specific resistivity. The excess carbon layer in the circular outer part is originated from the re-pyrolysis and deposition of hydrocarbon volatiles. The removal of the carbon by oxidative treatment may affect the surface property and also promote the magnitude of specific resistivity. The influence of the surface property on the specific resistivity can be considerable and should not be neglected.

Key words: silicon carbide fiber; excess carbon layer; specific resistivity

# **1** Introduction

Polymer-derived SiC fiber is highly valued because of its excellent heat-resistance, and used as reinforcement for PMC, MMC and CMC [1-4]. Not only is the heat-resistance attracting much attention, but the electrical properties of the fibers are also of great interest. SiC fibers are *n*-type semiconductors with a resistivity between  $10^{-1}$  and  $10^7 \ \Omega \cdot cm$  [5]. For example, the resistivities of NL-400 (HVR) and NL-500 (HVR) fibers commercialized by the Nippon Carbon company are  $10^6 - 10^7$  and 0.5 - 5.0  $\Omega$ ·cm, respectively. The formerreinforced PMC can be used as structural materials for radar domes and aircrafts based on its excellent microwave permeability, and the latter can be used in the development of structural materials for microwave absorbers based on its excellent microwave absorption [6].

The electrical behavior of SiC fibers is closely dependent on their chemical and structural properties [7,8]. Generally, the magnitude of the specific resistivity is controlled by free carbon content and  $\beta$ -SiC crystals present in the fibers. In the present work, the specific resistivities of four fibers prepared from the pyrolysis of organosilicon precursors were studied in correlation with their chemical and structural properties, and found that the surface structure affects the specific resistivity notably.

# 2 Experimental

Continuous polycarbosilane green fibers were cured with atmospheric oxygen. Pyrolysis of the cured PCS fiber in flowing nitrogen gas was conducted continuously in a tube furnace at the temperature of 1300–1400 °C [9], and the ultimate product was named as SiC–1 fiber. The PCS fibers were cured with atmospheric oxygen, cyclohexene and  $\gamma$ -ray irradiation [10,11], respectively. Then the cured fibers were heated to 1300–1400 °C in flowing nitrogen at a rate of about 100 °C/h, and the ultimate products were named as SiC–2, SiC–3 and SiC–4 fibers, respectively.

The bulk composition of fibers was determined by chemical analysis. Solid-state nuclear magnetic resonance (<sup>29</sup>Si NMR) of the SiC fibers was obtained on a Bruker AV300 spectrometer using stander Bruker double-resonance magic-angle sample spinning (MAS) probes. Using the two-terminal method to determine the electrical resistivity, both ends of a monofilament were attached with electro conductive resin to the electrode plates which were 25 mm (*L*) apart in distance, the specific resistivity was derived by:  $\rho_v = RS/L = R\pi d^2/(4L) = 10^{-9}R\pi d^2$ , where *R*, *S* and *d* represent resistivity, cross-

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sectional area and diameter of SiC fibers, the value of resistivities was the average of about 20 measurements. The crystallinity of the SiC fibers was detected via X-ray diffraction, using diffractometer with Cu K<sub> $\alpha$ </sub> radiation; Microstructural analysis was carried out using high-resolution transmission electron microscopy (HRTEM). Depth profiles of SiC fibers were measured by Auger electron spectroscope (AES) with a PHI–610/SAM analyzer.

# **3** Results and discussion

#### **3.1 Composition**

The composition and specific resistivities of the four SiC fibers are listed in Table 1.

Table 1 Chemical composition of four SiC fibers

Fiber type	w(Si)/%	w(C)/%	w(O)/%	n(C)/n(Si)	Specific resistivity/ (Ω·cm)
SiC-1	51.9	27.4	18.1	1.23	3.6×10 <sup>-1</sup>
SiC-2	50.5	28.3	13.9	1.31	$4.0 \times 10^{3}$
SiC-3	52.5	32.6	9.4	1.45	$2.2 \times 10^{2}$
SiC-4	54.1	39.1	1.41	1.69	$6.7 \times 10^{-1}$

The specific resistivities of the four fibers are  $3.6 \times 10^{-1}$ ,  $4.0 \times 10^{3}$ ,  $2.2 \times 10^{2}$  and  $6.7 \times 10^{-1} \Omega \cdot cm$ , the mole ratios of C to Si of the four fibers are 1.23, 1.31, 1.45 and 1.69, respectively. Generally, the magnitude of the specific resistivity is mainly controlled by free carbon phase present in the fibers; the more the free carbon content is, the higher the specific resistivity is [7]. The free carbon content cannot be demonstrated by the total carbon content and the mole ratio of C to Si for the silicon and the carbon have several kinds of tetrahedral environment besides SiC4 structure. Solid <sup>29</sup>Si NMR can describe the tetrahedral environment of silicon atoms and evaluate the ratio between each entity. <sup>29</sup>Si NMR spectra of the four fibers are shown in Fig. 1.



Fig. 1<sup>29</sup>Si MAS NMR spectra of four SiC fibers

Four types of silicon environments are detected in the fibers with resonances centered around  $-15 \times 10^{-6}$ ,  $-30 \times 10^{-6}$ ,  $-72 \times 10^{-6}$  and  $-107 \times 10^{-6}$  which can be assigned to the presence of SiC<sub>4</sub>, SiO<sub>2</sub>C<sub>2</sub>, SiCO<sub>3</sub> and SiO<sub>4</sub> entities [12], respectively. The relative ratios of each entity are shown in Table 2.

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Fiber	$SiC_4$	$SiC_2O_2$	SiCO <sub>3</sub>	${\rm SiO}_4$	$w(SiC_xO_y)$	w(SiO <sub>4</sub> )/%
SiC-1	1	0.39	0.33	0.20	37.5	10.5
SiC-2	1	0.22	0.21	0.12	27.7	7.7
SiC-3	1	0.18	0.14	0.10	22.5	7.0
SiC-4	1	0	0	0	0	0

As shown in Table 2, the content of ternary amorphous silicon oxycarbide  $(SiC_xO_y)$  structure involved with  $SiC_2O_2$  and  $SiCO_3$  in the SiC-1 fiber is 37.5% (mole fraction), higher than that of the SiC-2, SiC-3 or SiC-4 fiber which are 27.7%, 22.5% and 0. The same result can also be found in the fibers with the  $SiO_4$  structure, the content of  $SiO_4$  structure in SiC-1fiber is 10.5%, higher than the SiC-2, SiC-3 or SiC-4fiber which are 7.7%, 7.0% and 0, respectively.

The SiC<sub>x</sub>O<sub>y</sub> structure can be described by Si sites bonding with *x* carbon neighbors and *y*-oxygen neighbors, and corresponds to the chemical formula of SiC<sub>x/4</sub>O<sub>y/2</sub> when one carbon can bond with four Si atoms and one oxygen can bond with two Si atoms. The chemical formulas of the tetrahedral structures such as SiC<sub>4</sub>, SiC<sub>2</sub>O<sub>2</sub>, SiCO<sub>3</sub> and SiO<sub>4</sub> are SiC, SiC<sub>1/2</sub>O, Si<sub>1/4</sub>O<sub>3/2</sub> and SiO<sub>2</sub>, respectively. The structure of the three SiC fibers can be described by  $(SiC)_a/(SiC_{1/2}O)_b/(SiC_{1/4}O_{3/2})_c/(SiO_2)_a/C_f)$  and can be integrated into SiC<sub>x</sub>O<sub>y</sub>/C<sub>f</sub> concisely. The free carbon content can be figured out by the <sup>29</sup>Si NMR spectra and the chemical analysis results.

Table 3 Free carbon content data of four SiC fibers

Fiber	Formula <sup>1)</sup>	Formula <sup>2)</sup>	$\Delta f$	Free carbon content/%
SiC-1	SiC <sub>1.23</sub> O <sub>0.61</sub>	SiC <sub>0.67</sub> O <sub>0.67</sub>	0.56	19.7
SiC-2	SiC <sub>1.31</sub> O <sub>0.48</sub>	SiC <sub>0.75</sub> O <sub>0.50</sub>	0.56	20.1
SiC-3	SiC <sub>1.45</sub> O <sub>0.31</sub>	SiC <sub>0.79</sub> O <sub>0.41</sub>	0.66	23.9
SiC-4	SiC <sub>1.69</sub> O <sub>0.046</sub>	$SiC_1O_0$	0.69	25.5

1) Calculated by chemical analysis; 2) Calculated by Si MAS NMR spectra

The difference of mole ratio of O to Si calculated by the <sup>29</sup>Si NMR spectra and the chemical analysis results is acceptable and can be ignored. The <sup>29</sup>Si NMR results subtracted from the chemical analysis results give the free carbon content. The free carbon contents of the four fibers are 19.7%, 20.1%, 23.9% and 25.5%, respectively.

As mentioned above, the magnitude of the specific

resistivity is mainly controlled by the free carbon phase, and this can explain that the SiC-4 fiber which has a higher free carbon content possesses a low specific resistivity. The SiC-1 fiber and SiC-2 fiber exhibit nearly the same free carbon content, but the electrical resistivity of the SiC-1 fiber is  $3.6 \times 10^{-1} \Omega$ ·cm, nearly 3 or 4 orders of magnitude lower than that of the SiC-2 fiber or SiC-3 fiber which are  $4.0 \times 10^3 \Omega$ ·cm and  $2.2 \times 10^2$  $\Omega$ ·cm, respectively. This result indicates that the low electrical resistivity of the SiC-1 fiber is not originated from the free carbon content.

## **3.2 Crystallization**

The XRD patterns of the fibers are shown in Fig. 2. The three intense peaks of the SiC-2 fiber, SiC-3 fiber and the SiC-4 fiber are at  $2\theta \approx 36.5^\circ$ ,  $60^\circ$  and  $72^\circ$ , which correspond to the diffraction lines from (111), (220) and



Fig. 2 XRD patterns of four SiC fibers

(311) lattice planes of  $\beta$ -SiC crystals, respectively. Conversely, the SiC-1 fiber exhibits no tendency towards crystallinity, and only one peak indexed as the (111) reflection is observed.

The inability to crystallize in SiC-1 fiber is ascribed to the presence of excess oxygen. In Si-C ceramic systems prepared by precursor route, the presence of hetero-atoms such as oxygen and nitrogen in the bulk Si-C matrix will depress and retard the progress of  $\beta$ -SiC crystallization [13,14]. It is unsurprisingly that the SiC-1 fiber with high oxygen content will keep being amorphous at 1300–1400 °C. By contrast, The SiC-2, SiC-3 and SiC-4 fibers with a notable reduction in oxygen content show intense diffraction peaks of  $\beta$ -SiC crystal.

TEM images are in good agreement with the XRD results. The bright-field image (Fig. 3(a)) shows a very smooth microstructure and indicates that there is no polycrystalline microstructure in the SiC-1 fiber. Whereas,  $\beta$ -SiC crystal stacks can be found in Figs. 3(b)-(d), suggesting that  $\beta$ -SiC crystals do exist in the SiC-2, SiC-3 and SiC-4 fibers.

The specific resistivity of the pure  $\beta$ -SiC is  $7 \times 10^{-3}$  $\Omega \cdot \text{cm}$  [5]. Generally, the magnitude of specific resistivity of SiC fibers will decrease with the evolution of  $\beta$ -SiC crystals. The SiC-1 fiber which shows no tendency towards crystallinity should exhibit a higher electrical resistivity than the SiC-2 or SiC-3 fiber, but the result is quite different, indicating that the low specific resistivity of the SiC-1 fiber did not come from the crystallization.



Fig. 3 HRTEM images of SiC fibers: (a) SiC-1; (b) SiC-2; (c) SiC-3; (d) SiC-4

#### 3.3 Surface structure

The free carbon content and the ability to crystallize are not the chief factors in determining the reasons of great difference in electrical resistivity among the three fibers. Still, another concern arises in the surface structure. In order to investigate the surface property, AES was adopted and the depth profile results of the fibers are shown in Fig. 4.

According to the results of AES analysis, it is evident that a carbon-rich layer with a thickness about 50 nm exists in the circular outer part of the SiC-1 fiber. In this area, carbon content is more than 97% (mole



**Fig. 4** AES depth profiles (a, b, c, d) and survey scans (a', b', c', d') of SiC fibers: (a), (a') SiC-1; (b), (b') SiC-2; (c), (c') SiC-3; (d), (d') SiC-4

fraction), and only carbon signal can be found in the survey scan result. Surface properties of SiC-2, SiC-3 and SiC-4 fibers are quite different. In the survey scan result, C, O and Si signals can be found simultaneously.

Because of the low electrical resistivity of carbon which is about  $10^{-6} \Omega \cdot \text{cm}$ , the SiC–1 fiber covered with the excess carbon layer has a very low electrical resistivity. The mass fraction of carbon layer can be evaluated by a simple model consisting of an exterior carbon sleeve and an interior column:

$$m_{\rm c}/m_{\rm f} = V_{\rm c}\rho_{\rm c}/V_{\rm f}\rho_{\rm f} \approx \pi D d\rho_{\rm c}/[\pi (D/2)^2 \rho_{\rm f}] = 4 d\rho_{\rm c}/(D\rho_{\rm f})$$
(1)

where *d* and *D* represent the thickness of the excess carbon layer and the fiber diameter;  $\rho_c$  and  $\rho_f$  denote the densities of carbon and the bulk SiC fiber; the values of the four factors are 50 nm, 14 µm, 2.0 g/cm<sup>3</sup> and 2.4 g/cm<sup>3</sup>, respectively. The mass fraction of the carbon layer calculated by equation above is only about 1.2%, but its influence on the specific resistance is considerable and should not be neglected.



Fig. 5 Model of SiC-1 fiber with excess carbon layer in circular outer part

It is worth to note that the electric behavior is evidently controlled by the free carbon content and the SiC grain size, but the two factors will no longer affect the specific resistivity notably with the time when the fiber is covered with a carbon-rich superficial layer like that observed on the SiC-1 fiber.

A very easy way to confirm the importance of surface property is to burn the excess carbon layer in the open air, and measure the resistivity again. The bearable temperatures of normal carbon structure and SiC<sub>x</sub>O<sub>y</sub> in oxidative atmosphere are 400 °C and 700 °C [15,16], respectively. Therefore, to expose the SiC–1 fiber to the open air at 500–600 °C would be effective to remove the carbon layer. AES depth profiles and specific resistivity of the SiC–1 fiber after thermal exposure at 600 °C are shown in Figs. 6 and 7, respectively.

Removal of the carbon by oxidative treatment affects the surface property and also promotes the magnitude of specific resistivity. After thermal exposure



**Fig. 6** AES depth profiles (a) and survey scan (b) of SiC-1 fiber after thermal exposure at 600  $^{\circ}$ C



**Fig. 7** Results of electrical resistivity  $(\rho_v)$  tests before (a) and after (b) thermal exposure to air (*N* is number of fiber)

to the open air, the content of C falls from 97% to 38% (mole fraction). Besides the C signal, O and Si signals can also be detected in the survey scan resulting from the content of 54% and 8% (mole fraction). The specific resistivity ranges from  $3.6 \times 10^{-1} \Omega \cdot cm$  to  $2.5 \times 10^4 \Omega \cdot cm$ .

#### 3.4 Formation of carbon layer

Surface structure of SiC fibers is closely connected with the pyrolysis technological operation. The gas evolution of the cured polycarbosilane fiber during pyrolysis is shown in Fig. 8.



Fig. 8 Gas evolution during pyrolysis of cured polycarbosilane fiber

As shown above, m/z values of the three main gaseous products in evolution in the temperature ranging from 600 to 800 °C are 2, 16 and 15, and can be assigned to H<sub>2</sub>, CH<sub>4</sub> and — CH<sub>3</sub>, respectively. The gaseous products result from the decomposition of the side chains such as Si—H and Si—CH<sub>3</sub>.

Manufacture of the SiC–1 fiber was conducted continuously in a tube furnace at the temperature of 1300–1400 °C, the organic molecules of the cured PCS fiber will suffer from a huge thermal shock suddenly and convert into inorganic Si—C networks accompanied by gas evolution. The hydrocarbon volatiles, such as  $CH_4$ which can be regarded as carbon resource, will do re-pyrolysis and deposit on the SiC fiber at a high temperature in the tube furnace. It goes on without saying that the process is a chemical vapour deposition (CVD). Re-pyrolysis of hydrocarbon volatiles makes the SiC fiber carbon excess on the peripheral surface.

$$CH_4(g) \rightarrow C(s) + 2H_2(g)$$
 (2)

The starting temperature of deposition with assumption that graphite carbon and hydrogen are pyrolysis products of the  $CH_4$ , neglecting the chemical kinetics, can be evaluated by the thermodynamic equation. The expression for the free energy of the pyrolysis is given by:

$$\Delta_{\rm r}G_{\rm m}(T) = \Delta_{\rm r}G_{\rm m}^{\Theta}(T) + RT \ln Q_{\rm f} = \Delta_{\rm r}H_{\rm m}^{\Theta}(T_{\rm c}) - T\Delta_{\rm r}S_{\rm m}^{\Theta}(T_{\rm c}) + \int_{T_{\rm c}}^{T}\Delta c_{p} dT - T\int_{T_{\rm c}}^{T}\frac{\Delta c_{p}}{T} dT + RT \ln \frac{(f_{\rm H_{2}}/p^{\Theta})^{2}}{(f_{\rm CH_{4}}/p^{\Theta})} = \Delta_{\rm r}H_{\rm m}^{\Theta}(T_{\rm c}) - T\Delta_{\rm r}S_{\rm m}^{\Theta}(T_{\rm c}) + \int_{T_{\rm c}}^{T}\Delta c_{p} dT - T\int_{T_{\rm c}}^{T}\frac{\Delta c_{p}}{T} dT + RT \ln \frac{(\gamma_{\rm H_{2}}p_{\rm H_{2}}/p^{\Theta})^{2}}{(\gamma_{\rm CH_{4}}p_{\rm CH_{4}}/p^{\Theta})}$$
(3)

where  $\Delta_r^{\Theta} G_m(T)$  and  $Q_f$  are the standard free energies in atmospheric pressure and quotient of fugacity, respectively;  $f_{\rm H_2}$ ,  $f_{\rm CH_4}$  and  $\gamma_{\rm H_2}$ ,  $\gamma_{\rm CH_4}$  represent the fugacities and fugacity parameters of H<sub>2</sub> and CH<sub>4</sub>, respectively. The theoretical deposition temperature in the atmospheric pressure, implying that  $\Delta_r^{\Theta} G_m(T) = 0$ , is 560 °C. In practice, the value exhibits large deviation for two reasons: 1) the evolution of CH<sub>4</sub> from the pyrolysis of the chains, such as Si-H and Si-CH<sub>3</sub>, starting at 550 °C [17] and the PCS fiber was started to decompose at the theoretical temperature; 2)  $Q_{\rm f}$  cannot be neglected when the pressures of CH<sub>4</sub> and H<sub>2</sub> are not within the atmospheric pressure. The practical deposition temperature will increase with the introduction of  $RT \ln O_{\rm f}$ in Eq. (3). Despite of the two reasons, the deposition will happen at a high temperature of 1300-1400 °C, the volatiles, such as CH<sub>4</sub>, will do re-pyrolysis and form an excess carbon layer on the SiC fibers.

In the cases of the SiC-2 fiber and SiC-3 fiber, the cured fibers sustain the increasing heat by a slow degree, and the organic-inorganic transition is relatively slow; hydrocarbon volatiles which can be regarded as carbon resources are almost blew away by the inert gas flow; the absence of sufficient carbon resource makes the deposition of carbon impossible. Therefore, the surfaces of the two fibers were not excess carbon, and the value of electrical resistivity was relatively high.

### **4** Conclusions

1) The electrical properties of several SiC fibers prepared from the pyrolysis of organosilicon precursors were studied in correlation with their chemical and structural properties. The excess carbon layer with a thickness of about 50 nm existing in the circular outer part is the main reason for the low electrical resistivity of SiC-1 fiber. And the surface structure can also affect the specific resistivity of SiC fiber, as well as the free carbon content and the crystallization.

2) Formation of the excess carbon layer is closely connected with the technological operation. The quick achievement of organic–inorganic transition is accompanied by vigorous  $CH_4$  liberation, and thenpyrolysis and deposition of  $CH_4$  will make SiC fiber carbon excess on the peripheral surface.

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# 组成和结构对 SiC 纤维电阻率的影响

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**摘 要:**通过烧成制备电阻率不同的 4 种 SiC 纤维,并对纤维的元素组成、结晶性能和表面结构进行分析。结果 表明:通过调整不熔化及烧成工艺参数可以获得电阻率量级不同的 SiC 纤维。当纤维表层具有一定厚度的高富碳 层结构时,纤维的电阻率受整体自由碳含量与结晶性能的影响不显著,此时,纤维具有较低的电阻率。富碳层的 产生与不熔化纤维烧成时分解产生的烃类小分子的重新裂解沉积有关。通过低温氧化除去纤维表面的富碳层可以 使纤维的电阻率增大。表面结构对连续 SiC 纤维的电阻率有重要影响。 关键词: SiC 纤维;富碳层;电阻率

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